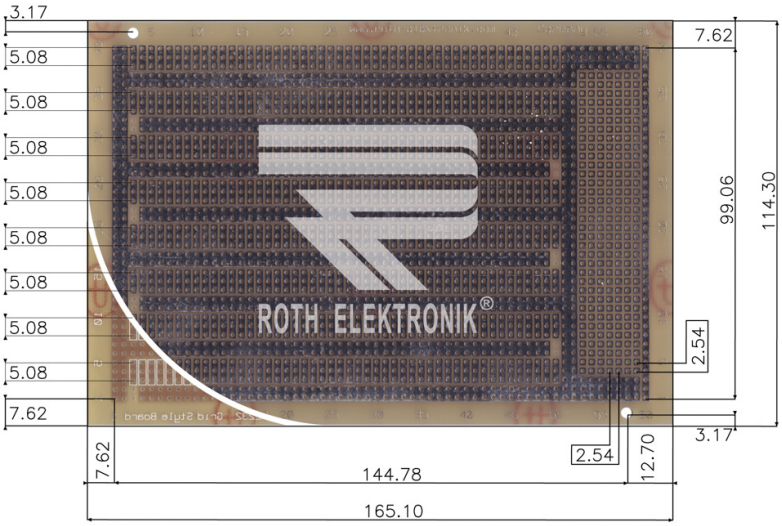


**RE232-LF**

- Epoxy fibre-glass FR4 1.60 mm
- Single-side 35 µm Cu
- Hot air leveling (HAL-leadfree)
- Component print
- Hole spacing 2.54 x 2.54 mm
- 40 x 60 tracks of bored holes
- 3-hole pads
- Hole diameter 1.02 mm (0.40")
- 4 rows DIP IC grid 7.62 mm, 15.24 mm with 48 terminal pins
- Max. working temperature 150 °C (320 °F)
- Size 114.30 mm x 165.10 mm (4.5" x 6.5")



Roth Elektronik GmbH
Industriestr. 4
65594 Runkel-Steeden

Phone: +49 (0)261 134978 - 08

E-Mail: info@roth-elektronik.com

Managing Director Mike Teschke
***Register*** Limbrug HRB 7172
***VAT ID no.*** DE1481222609

***Hamburger Volksbank***
***IBAN*** DE30 2019 0003 0032 3184 05
***BIC*** GENODEF1HH2